

# **Evaluating Constraints on Heavy-Ion SEE Susceptibility Imposed by Proton SEE Testing and Other Mixed Environments**

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# Acronyms and Symbols



**CL=Confidence Level**

**DSEE=Destructive Single-Event Effects**

**GCR=Galactic Cosmic Ray**

**HI=Heavy Ion**

**LET=Linear Energy Transfer**

**LET<sub>0</sub>=Onset LET**

**LET<sub>EQ</sub>=Equivalent Linear Energy Transfer=energy deposited in SV, divided by product of SV depth and SV density.**

**pdf=probability density function**

**$\rho$ ="rho"=density of Si (2.33 g/cm<sup>3</sup>)**

**s, W=Shape and width parameters for the Weibull distribution/form**

**SEB=Single-Event Burnout**

**SEE=Single-Event Effect**

**SEGR=Single-Event Gate Rupture**

**SEL=Single-Event Latchup**

**SOTA=State Of The Art**

**SDRAM=Synchronous Dynamic Random Access Memory**

**SRAM=Static Random Access Memory**

**SPE=Solar Particle Event**

**SV=Sensitive Volume**

**$\sigma$ ="sigma"=Cross section**

**$\sigma_{\text{sat}}$ =Saturated Cross Section**

**TID=Total Ionizing Dose**

**Xstr=transistor**

**Z=Atomic number of a nucleus or atom=# of protons in nucleus**

# Can Heavy-Ion Rates Be Bounded with Protons

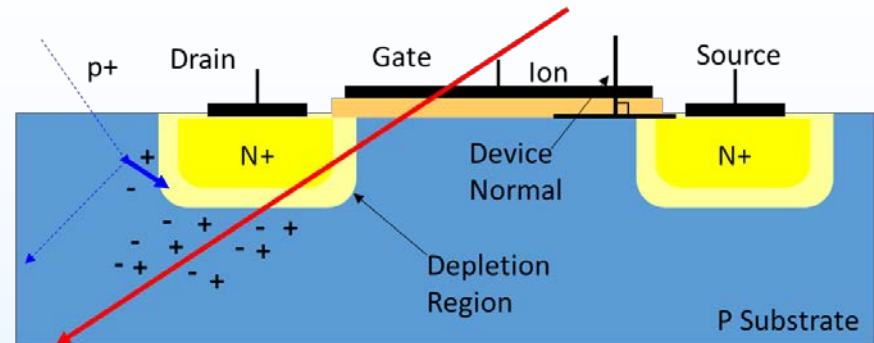
- **Heavy Ion (HI) Testing:**

- Is Expensive
- Is Time-Consuming
- Requires extensive modification of test parts
- Increasingly difficult to schedule
- Some parts may be nearly impossible to test w/ normal accelerator ions.
- Very hard to test boards/boxes.

- **Proton testing**

- Causes SEE via recoil ions
  - $3 \leq Z \leq 15$
- Produces ions reaching sensitive volumes even in difficult parts
- Allows board/box-level testing
  - Promises significant savings in cost and schedule

- **Can Heavy-Ion SEE rates be bounded with proton data?**

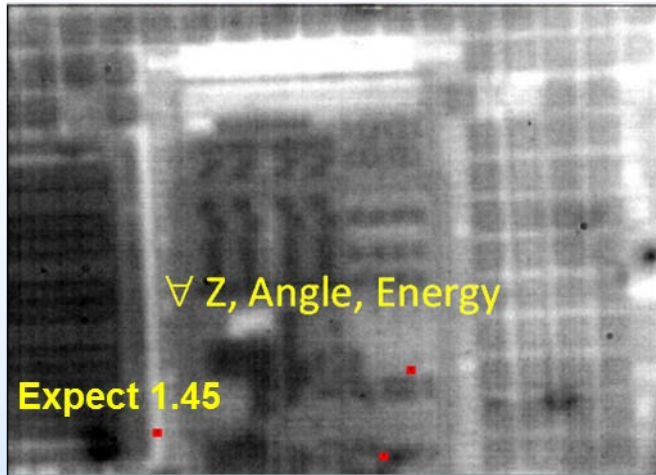


## Some Challenges w/ protons

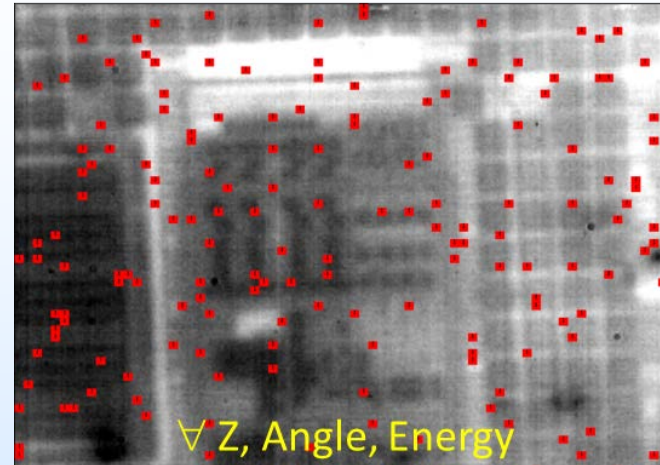
- **Protons inefficient at producing ions**
  - $\sim 1/2.9E5$  200-MeV protons produces a recoil ion; all contribute dose
- **We don't know Z, energy, angle or LET of an ion that causes a given SEE**
- **Proton recoils low energy/short range**
  - Last year, showed this was very important for assessing destructive SEE susceptibilities
  - Cannot compare recoil to GCR or SPE ions
  - Introduce  $LET_{EQ} = \frac{E_{Dep}}{(\rho \times d)}$ ,  $\rho$ =Si density,  $d$ =depth of SEE SV
  - If  $LET \sim$  constant in SV,  $LET_{EQ} \sim$  Effective LET

# Coverage of SEE Tests

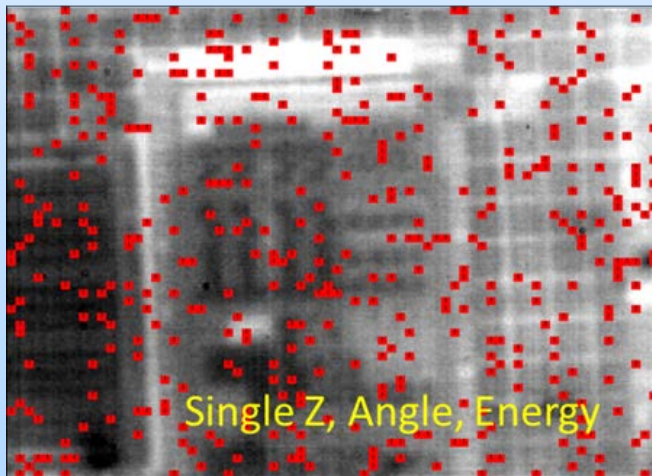
1E10 200 MeV protons/cm<sup>2</sup>



1E12 200 MeV protons/cm<sup>2</sup>

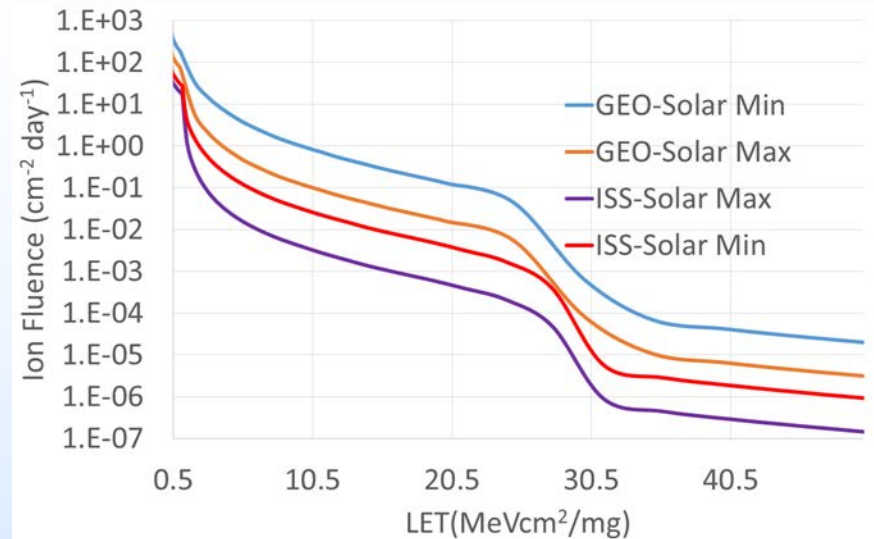
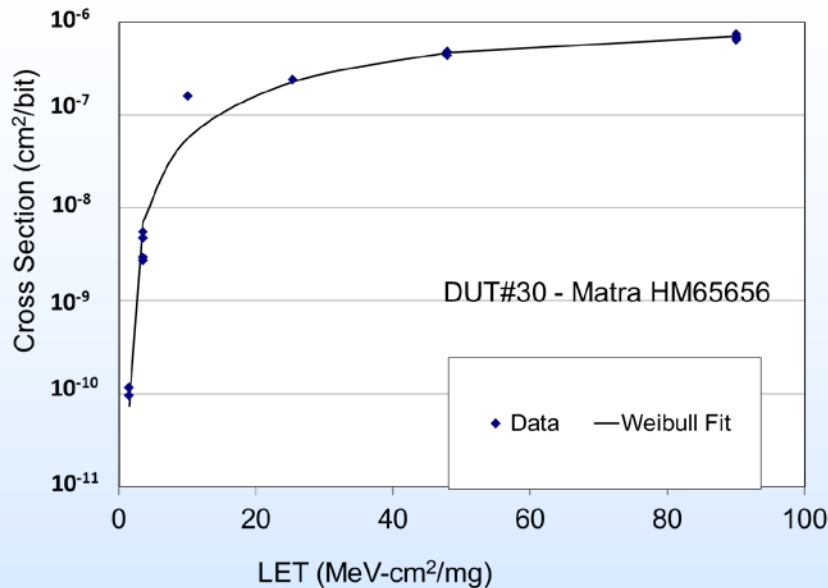


1E7 heavy ions/cm<sup>2</sup>



- Coverage of SEE test—how well it probes potentially vulnerable areas on test item
  - Units:  $\mu\text{m}^2$  per ion or transistors (xstr) per ion.
- IR photomicrograph of  $60 \times 70 \mu\text{m}^2$  area of ELPIDA EDS5108 512 Mbit SDRAM
  - Expect 1.45 recoil ions for  $10^{10}$  200-Mev p/cm<sup>2</sup>
- Intel I7 processor ~ 1 ion per 8000 xstr
  - Intel 8080 8-bit processor had 6000 transistors
- These are average values
  - 10% of parts could have missed areas  $> 78800 \mu\text{m}^2$

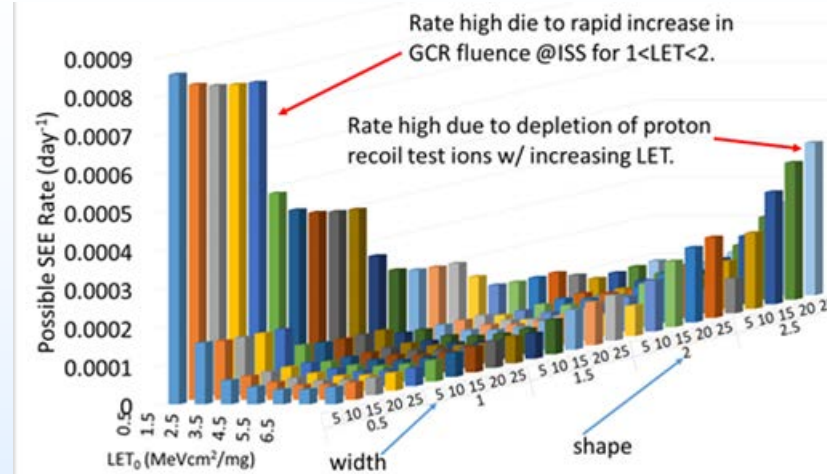
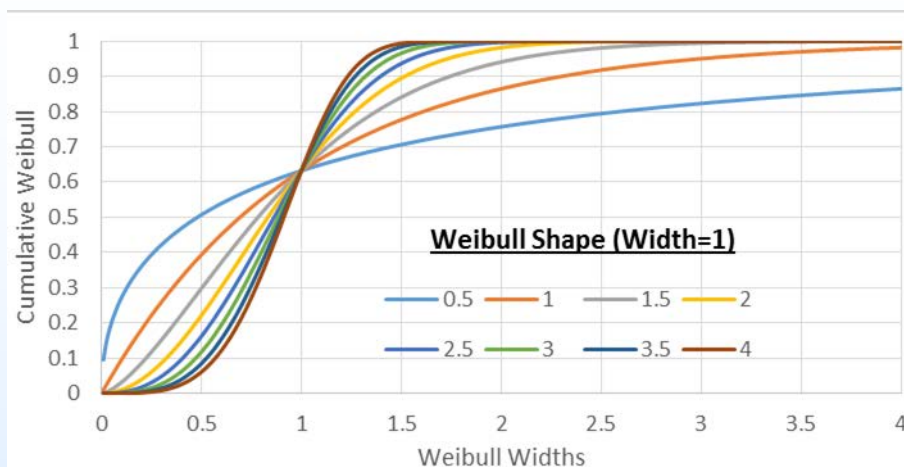
# But, Not All Ions Are Created Equal



- **Low-LET ions must hit much smaller cross section to cause SEE**
- **Ion fluence drops with LET in almost any environment**
  - Broader  $\sigma$  vs. LET (larger Weibull Width,  $W$ ) → lower rate
  - Larger shape parameter  $s$  → lower rate
- **Proton recoil fluences**
  - Very few proton recoil ions w/  $LET > 10 \text{ MeVcm}^2/\text{mg}$
  - Short range of proton recoils → fluence vs.  $LET_{EQ}$  drops even faster for deep SV



# SEE Rate Bounds for Shallow SV



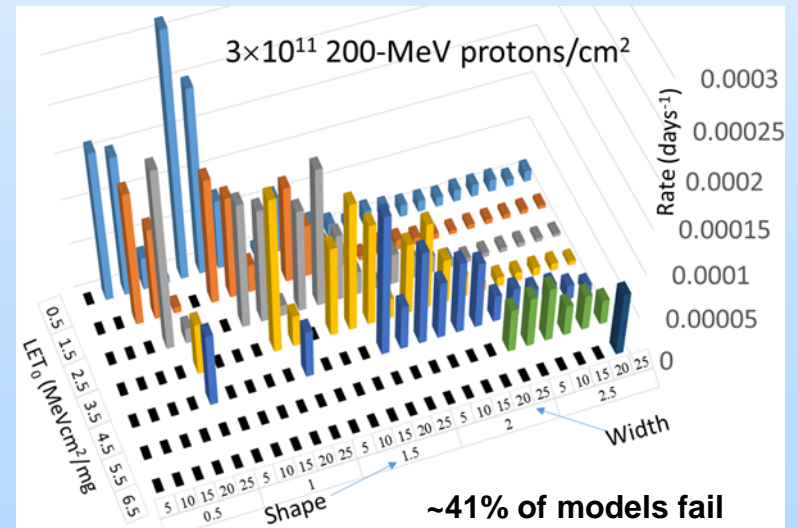
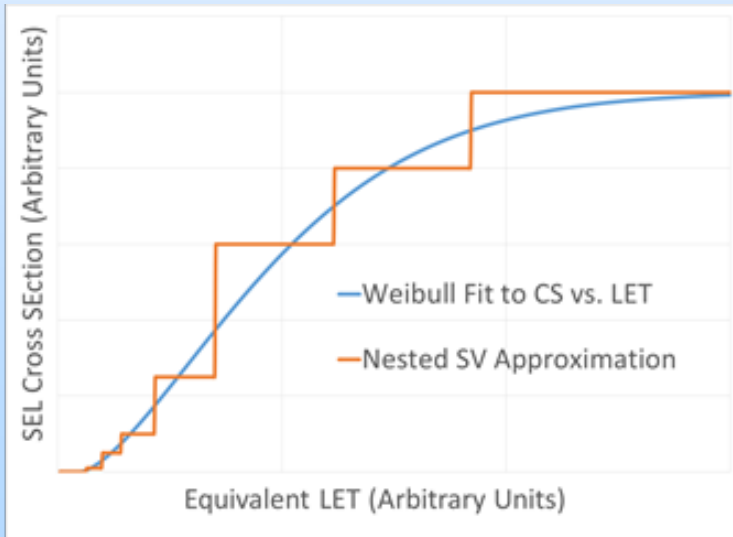
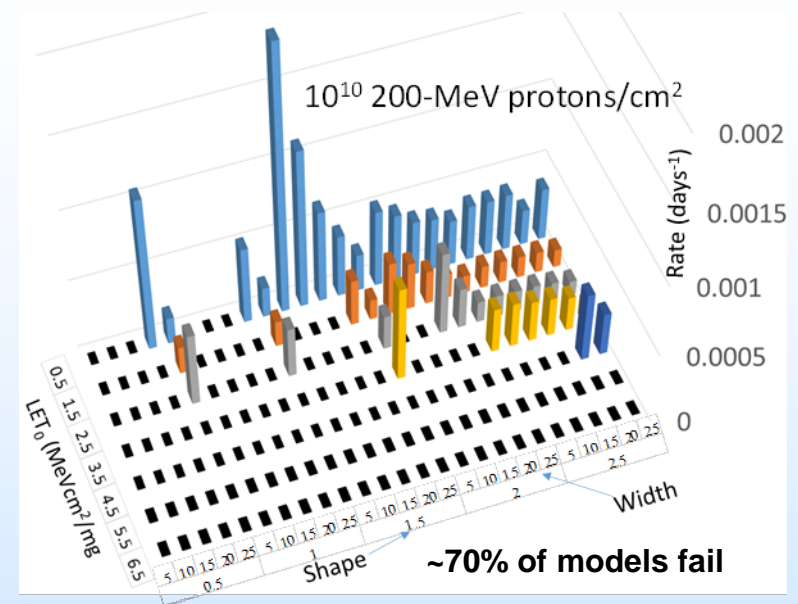
- Constraints from proton testing too weak to determine  $\sigma$  vs. LET, but event count can tell us which models are inconsistent with the proton data
- Assume device SV made up of  $N_{SV}$  representative 1-micron cube SVs
  - LET varies little across this sensitive volume, so  $LET_{EQ} \sim$  effective LET

$$N_E = \int_{LET_0}^{LET_{Max}} N_{SV} \times F(LET_{EQ}) \times \sigma(LET_{EQ}, LET_0, w, s) dLET_{EQ}$$

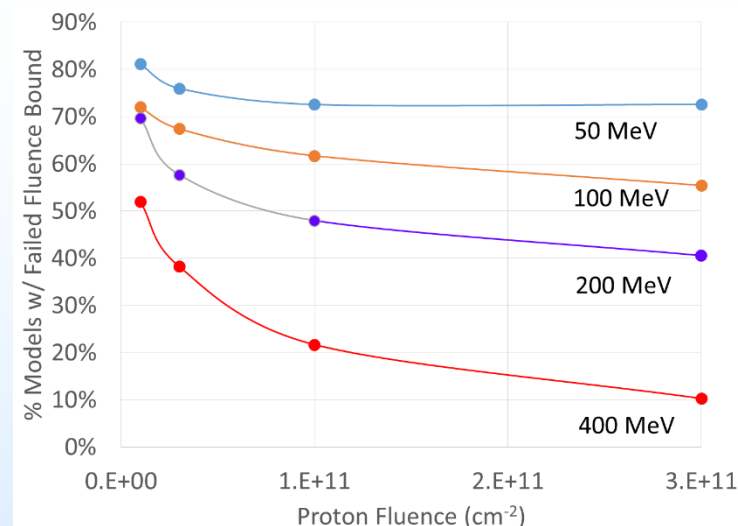
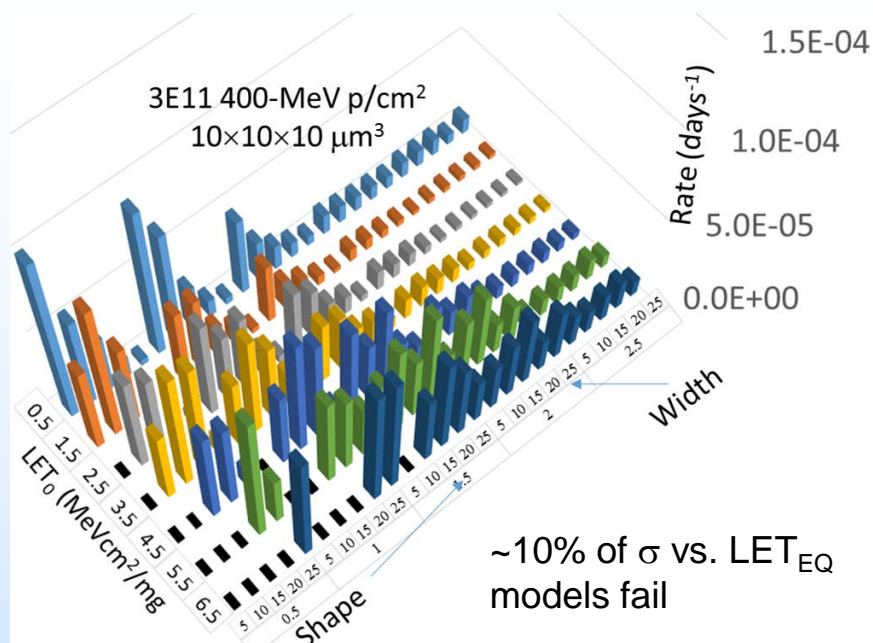
- Estimate # errors expected for a single 1-micron-cube SV for 175 representative models
  - $W=\{5, 10, 15, 20, 25\}$ ,  $s=\{0.5, 1, 1.5, 2, 2.5\}$ ,  $LET_0 = \{0.5, 1.5, 2.5, 3.5, 4.5, 5.5, 6.5 \text{ MeVcm}^2/\text{mg}\}$
- Solve for  $N_{SV}$  using upper bound on Poisson Mean for  $N_E$  (e.g. 2.31 for 90% CL if 0 events seen)
- Result: **Model performs worst at both high  $LET_0$  (where ions are scarce) and low  $LET_0$ , where increase in GCR fluence is more rapid than increase in fluence of recoil + cascade ions.**
- Note: CRÈME-MC emulator—uses stored CRÈME-MC results for proton recoils and CRÈME-96 rates for each candidate  $\sigma$  vs. LET model—can be generalized for any SV

# Deep SV Are More Challenging

- **Chord-length pdf changes as  $\sigma$  rises**
  - Use Nested SV to approximate  $\sigma$  vs. LET model
  - Use Fluence( $LET_{EQ}$ ) for SV depth
  - Estimate  $N_E$  and solve for  $N_{SV}$
- **For 10- $\mu$ m cube SV**
  - If device  $\sigma$  bound  $>10^{-2} \text{ cm}^2$ , method fails
  - For  $10^{10}$  200-MeV p/cm<sup>2</sup> 122 failures/175 models
  - For  $3E11$  200-MeV p/cm<sup>2</sup>, 40.6% of models fail
  - Protons can bound rate if fluence high,  $LET_0$  is low and  $\sigma$  vs.  $LET_{EQ}$  rises rapidly enough
  - Requires added information or assumptions

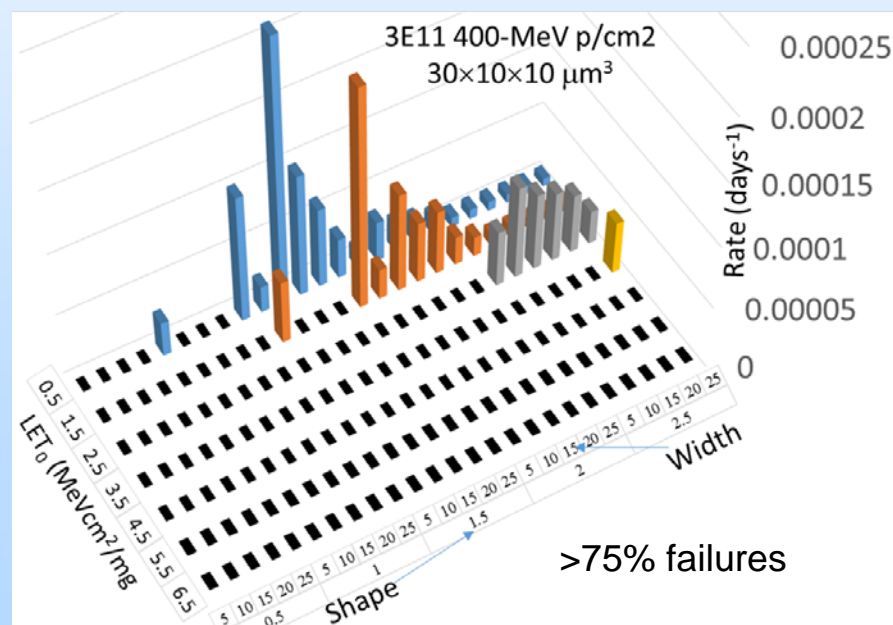


# Energy and Fluence Dependence



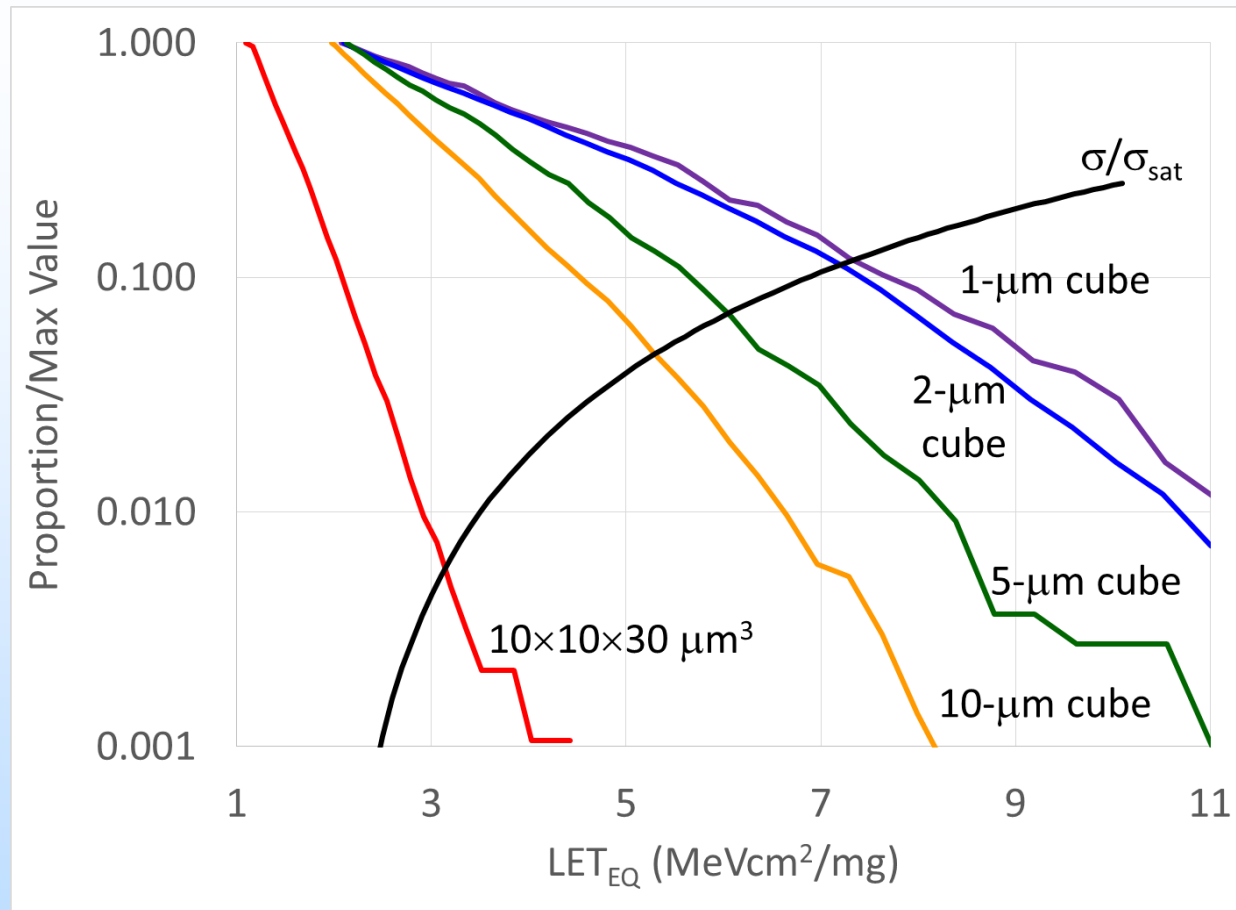
**Table I: Parameters w/ >50% Successful Bound**

Parameter	LET <sub>0</sub>	s	W
Fluence (cm <sup>-2</sup> )	(MeVcm <sup>2</sup> /mg)		
200 MeV, 10 <sup>10</sup>	< 2	< 1	< 10
200 MeV, 3×10 <sup>11</sup>	< 5	< 1.7	< 22
400 MeV, 10 <sup>10</sup>	< 3.5	< 1.2	< 12
400 MeV, 10 <sup>11</sup>	< 6.5	< 2.2	< 25



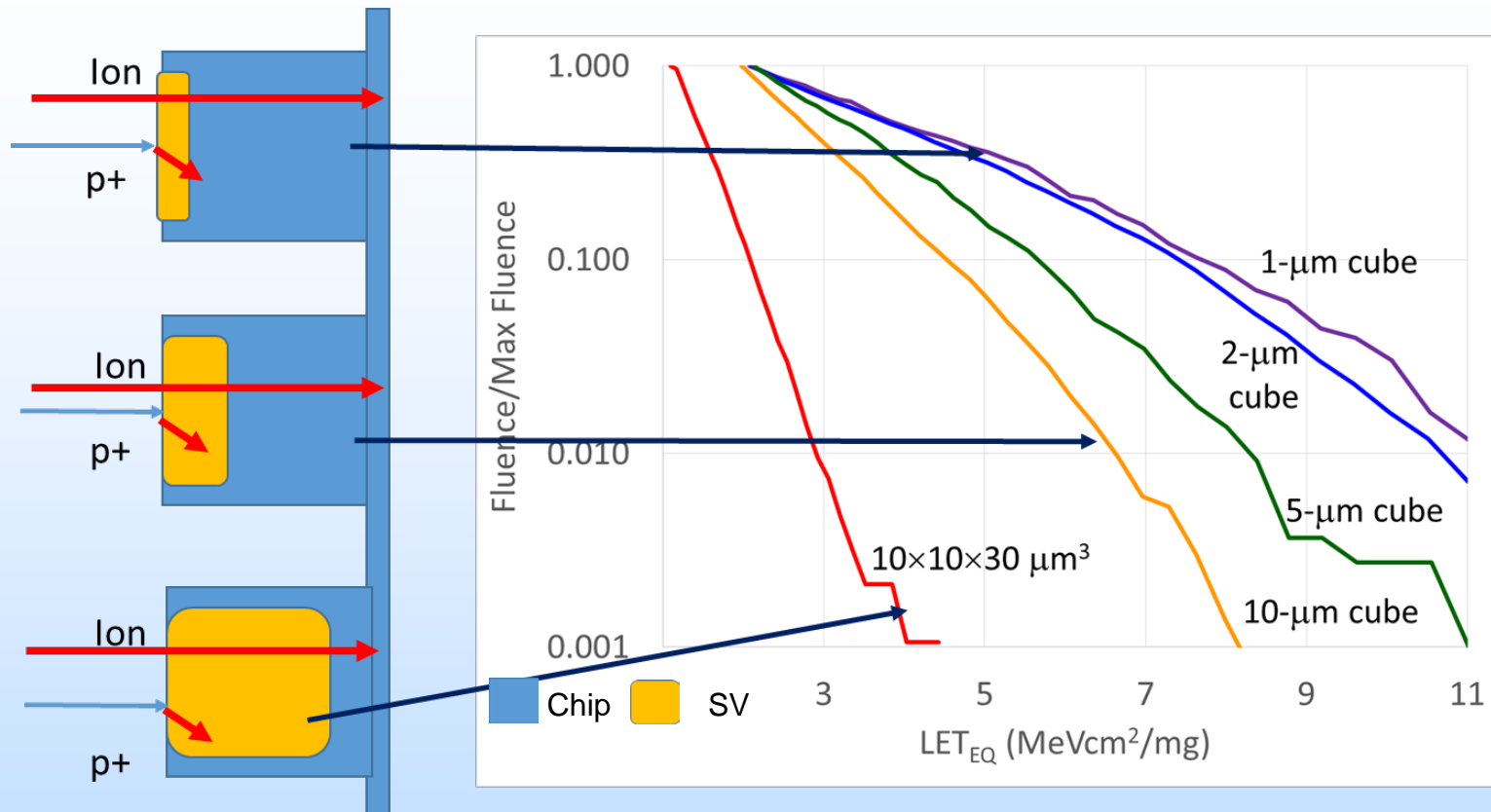


# Why Bounding Fails



- **Method fails to bound heavy-ion susceptibility if ion fluence falls faster then cross section rises vs. LET<sub>EQ</sub>. (high LET<sub>0</sub>, W or s).**
  - Deep SV push fluence distribution left—increasing likelihood of method failure

# Board/Box-Level Testing



- **Board/box-level testing irradiates many parts w/ diverse technologies**
  - Saves money, but different SV depths mean parts see different Fluence vs.  $LET_{EQ}$  dist.
  - Proton test may vary in effectiveness for every device on board
  - Need to know as much as possible about technology of each device to make sense of proton data

# Summary and Conclusions



- **Proton SEE data does constrain heavy-ion SEE performance**
  - Constraints may be weak due to important differences between recoils and GCR
- **Coverage key to whether test reveals SEE susceptibilities**
  - Ions per unit area or per transistor is a first approximation, but not all ions equally capable of causing SEEs
  - Rate bounds that consider potential  $\sigma$  vs. LET form are more informative
- **Shallow SV: LET~ constant through SV—bounding straightforward**
  - Consider  $\sigma$  vs. LET models for which proton recoils may be effective
    - $LET_0 \leq 6.5 \text{ Mevcm}^2/\text{mg}$ ,  $\text{width} \leq 25$ ,  $\text{shape} \leq 2.5$ —other models will perform worse.
  - Estimate rate for single SV—How many SVs possible for test to yield null result?
  - Bounding rate likely  $\leq 0.001/\text{day}$ —worst bounds at both low and high  $LET_0$
- **For deep SV, ions range limited—use nested SV approach**
  - Many plausible models fail to yield meaningful bound
  - Increased fluence and energy help, but only for SV depth  $\leq 10 \text{ } \mu\text{m}$
- **The problem is inherent to proton testing**
  - Charge deposited by proton recoils in deep SV limited by range, not LET
  - Fluence vs.  $LET_{EQ}$  compressed toward lower  $LET_{EQ}$ , where  $\sigma$
- **Applies to SEL—even worse for SEB/SEGR (coverage worse)**

# Possible Future Directions



- **Proton SEE data only weakly constrain HI SEE susceptibility**
  - Must supplement data with other information to increase effectiveness
    - E. g. constrain LET<sub>0</sub>, w, s,  $\sigma_{\text{sat}}$  w/ process and/or similarity data
    - Well suited to Bayesian treatment—as this makes subjective assumptions explicit
- **Current analysis predicated on DSEE physics of failure**
  - Need to understand SV geometry for DSEE better
  - Are there mitigating factors that would lead to tighter WC bounds on HI rates?
    - Cannot be ruled out, but no indication at present
- **Develop methods to make sense of board/box-level tests**
  - Fluctuations lead to worse coverage for some chips than others
    - Improves less than linearly with increased fluence
  - Different SV depths lead to exposure to different equivalent environments
    - Significantly complicates extrapolation of board-level proton tests to HI environment
  - For these reasons, board/box-level bounding rates must increase at least linearly with board/box complexity (e.g. # of parts)
- **Despite problems, proton testing may be the only option for many complicated highly integrated components**
- **One certainty: interpreting results will not be simple**